



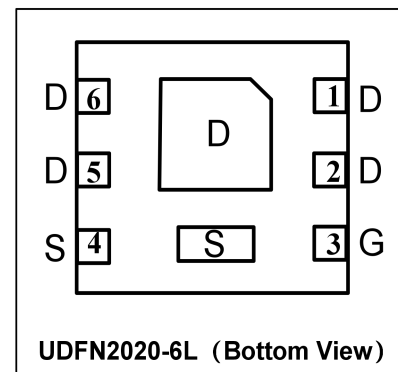
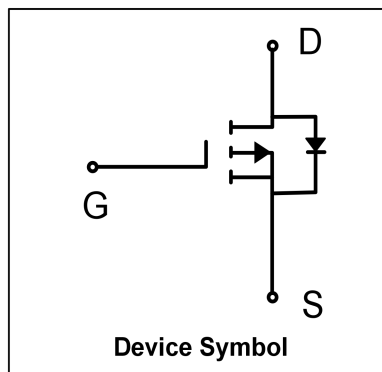
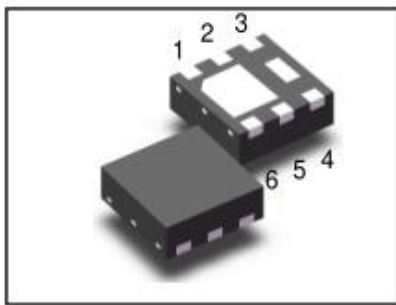
Features

- $V_{DS} = -30V$, $I_D = -11.5A$
 $R_{DS(on)} < 22m\Omega$ @ $V_{GS} = -10V$
 $R_{DS(on)} < 33m\Omega$ @ $V_{GS} = -4.5V$
- High Power and Current Handling Capability
- Fast Switching Speed
- Surface Mount Package

Mechanical Characteristics

- UDFN2020-6L Package
- Marking : Making Code
- RoHS Compliant
- MSL1

Schematic & PIN Configuration



Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Drain-Source breakdown voltage	V_{DS}	-30	V
Gate-Source voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-11.5	A
Pulsed Drain Current ¹	I_{DM}	-45	A
Power Dissipation	P_D	2.9	W
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55 to 150	$^{\circ}C$
Thermal Resistance from Junction to Ambient ²	$R_{\theta JA}$	43	$^{\circ}C/W$

Electrical Characteristics ($T_{amb}=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30V, V _{GS} = 0V	-	-	-1	μA
Gate-Body Leakage current	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Gate-Threshold Voltage ³	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.0	-1.6	-3.0	V
Drain-Source On-Resistance ³	R _{DS(on)}	V _{GS} = -10V, I _D = -9.1A	-	15	22	mΩ
		V _{GS} = -4.5V, I _D = -6.9A	-	21	33	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} = -15V, f =1MHz	-	1410	-	pF
Output Capacitance	C _{oss}		-	180	-	
Reverse Transfer Capacitance	C _{rss}		-	153	-	
Switching Characteristics						
Total Gate Charge ⁴	Q _g	V _{GS} = -4.5V, I _D = -9.1A, V _{DS} = -15V	-	18	-	nC
Gate-Source Charge ⁴	Q _{gs}		-	5.2	-	
Gate-Drain Charge ⁴	Q _{gd}		-	6.7	-	
Turn-on Delay Time ⁴	t _{d(on)}	V _{GS} =-10V V _{DD} = -15V, , R _G = 1Ω, R _L = 15Ω, I _D = -1A	-	10	-	nS
Rise Time ⁴	t _r		-	15	-	
Turn-off Delay Time ⁴	t _{d(off)}		-	53	-	
Fall Time ⁴	t _f		-	12	-	
Source-Drain Diode Characteristics						
Diode Forward Voltage	V _{SD}	I _S = -1A, V _{GS} = 0V	-	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface mounted on FR4 board using 1 square inch pad size, 1oz single-side copper.
3. Pulse Test: Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product

Typical Characteristics

Figure 1. Output Characteristics

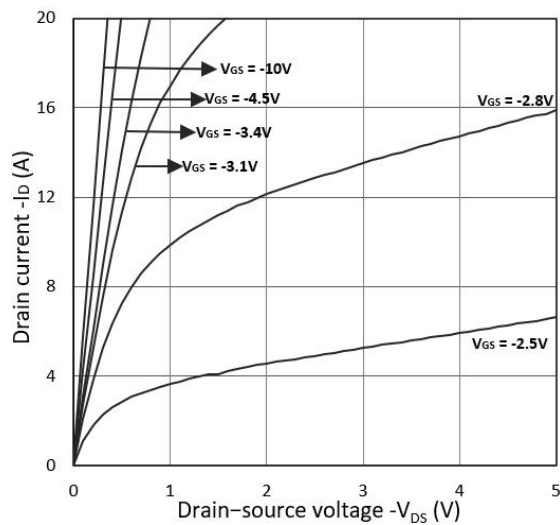


Figure 2. Transfer Characteristics

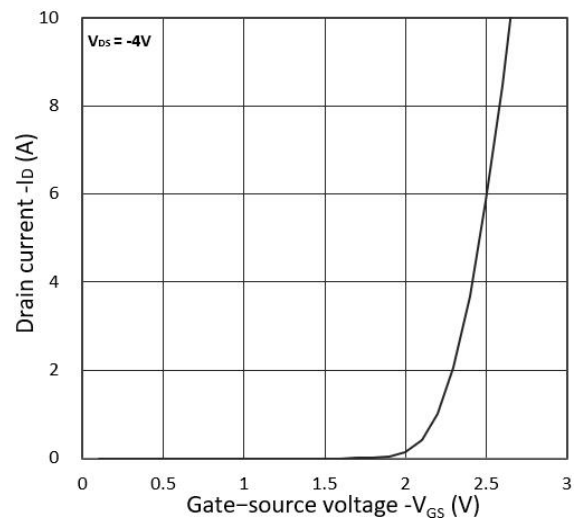
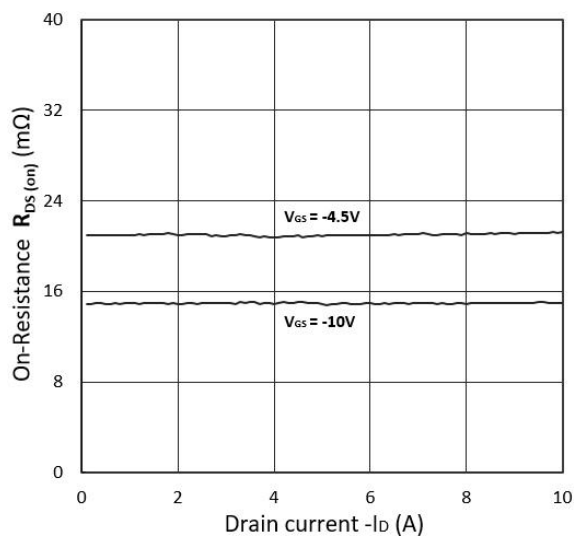
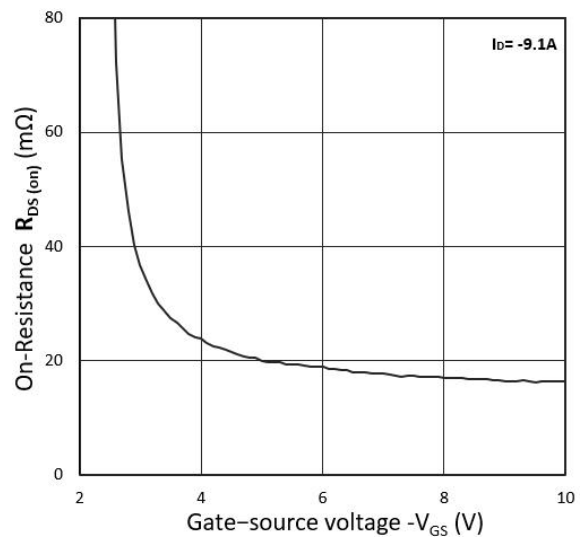
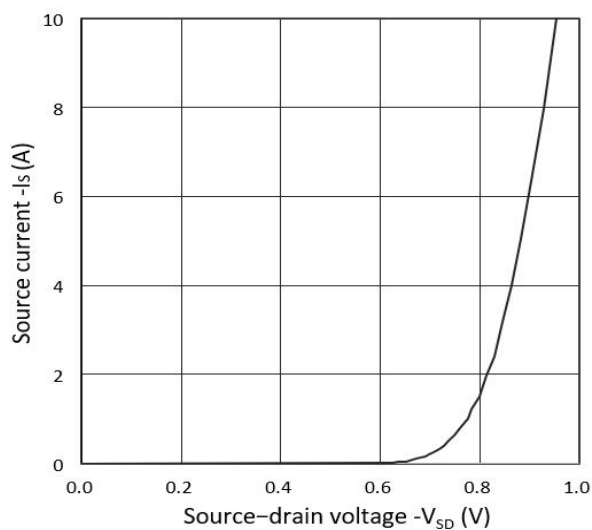
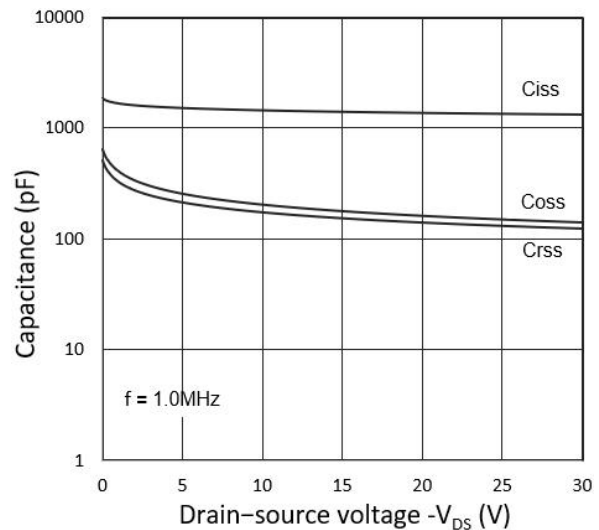
Figure 3. $R_{DS(ON)}$ vs. I_D Figure 4. $R_{DS(ON)}$ vs. V_{GS} Figure 5. I_S vs. V_{SD} 

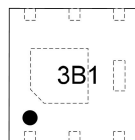
Figure 6. Capacitance Characteristics



Outline Drawing – UDFN2020-6L

PACKAGE OUTLINE			
SYMBOL	MILLIMETER		
	MIN	TYP	MAX
A	0.50	0.55	0.60
A1	0.00	0.02	0.05
A3	0.152REF		
b	0.25	0.30	0.35
D	1.95	2.00	2.05
E	1.95	2.00	2.05
e	0.65BSC		
L	0.25	0.30	0.35
L1	0.46	0.56	0.66
D1	0.80	0.90	1.00
E1	0.80	0.90	1.00

Marking Codes

Part Number	EM03P115R
Marking Code	

Package Information

Qty: 3k/Reel

Revision History

No.	Version	Date	Revision Item	Request	Function and characteristic checking	Package dimension checking	Typos checking
1	1.0	2019-11-08	Released Version	Qi Shu Kun	Qi Shu Kun	Liu Jia Ying	Liu Jia Ying